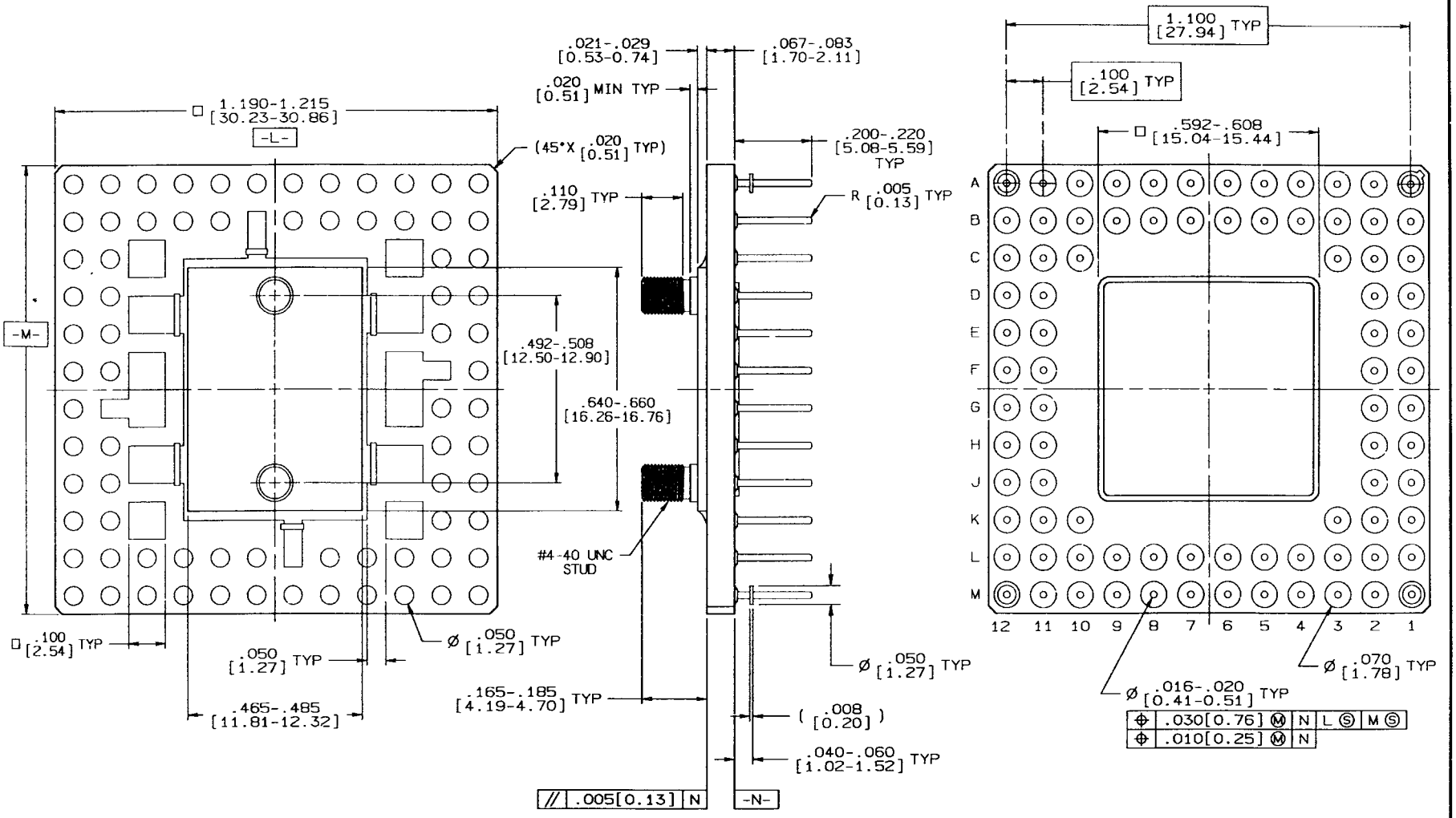
REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	09632	04/23/93	KES/



NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL EXPOSED METAL AND METALIZED AREAS TO BE GOLD PLATED 60 MICROINCHES/1.52 MICROMETERS MINIMUM OVER 50-350 MICROINCHES/1.27-8.89 MICROMETERS OF NICKEL.
2. NO JEDEC REGISTRATION AS OF 4-2-93.

CONTROLLING DIMENSION: INCH

APPROVALS	DATE
DRAWN	04/23/93
DSTG. CHK	05/06/93
ENGR. CHK	5/6/93
APPROVAL	

PROJECTION

INCH [MM]

NATIONAL SEMICONDUCTOR CORPORATION
2900 Semiconductor Drive, Santa Clara, CA 95052-8090

PIN GRID ARRAY, CERAMIC, 84 PIN, CAVITY DOWN, W/STUD

SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	MKT-UA84E	A

DO NOT SCALE DRAWING | SHEET 1 OF 1